

Supporting information for **Synergism of mechanical activation and sulfurization to recover copper from waste printed circuit boards**

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Table S1. Elemental compositions (wt%) in Area-IV~VI, Figure 1-B, from the energy dispersive X-ray analysis.

Type	C	O	Cu	Al	Au ^[a]
Area-IV	1.26	-	79.24	-	19.50
Area-V	12.35	2.01	58.43	-	27.21
Area-VI	38.02	21.08	3.15	0.41	37.33

[a] Au is sprayed on the surface of the samples to improve the conductivity during the SEM analysis.

Table 2. Specific species in Cu₂-xS and corresponding weight percentages (wt%) in different ball-milling time, from the two XRD analyses.

	5 min		10 min		15 min		20 min		25 min		30 min		40 min		60 min	
Cu ₂ S	15.02	18.13	22.65	22.17	20.08	26.69	18.09	18.13	26.90	31.27	40.12	38.89	53.89	57.77	54.09	60.49
Cu _{1.96} S	4.21	5.93	2.37	1.92	1.99	3.09	1.80	-	1.12	1.62	-	-	-	-	-	-
Cu _{1.95} S	2.95	-	-	3.98	-	-	-	-	-	-	-	-	-	-	-	-
Cu _{1.92} S	-	-	4.04	-	-	-	-	-	-	-	-	-	-	-	-	-

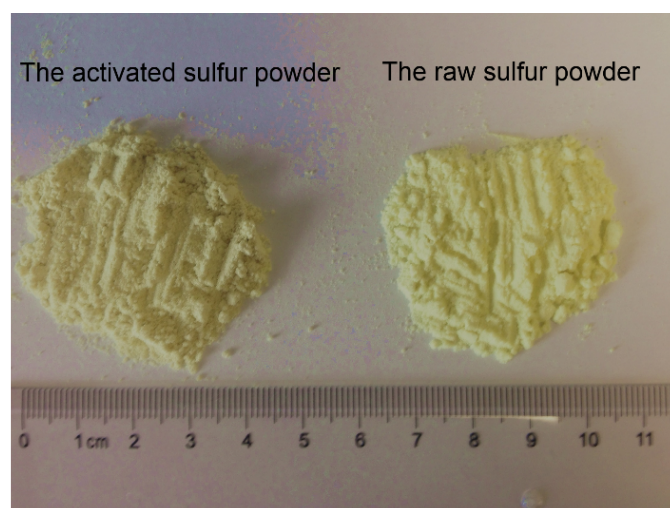


Figure S1. The raw sulfur powder and the activated sulfur powder.

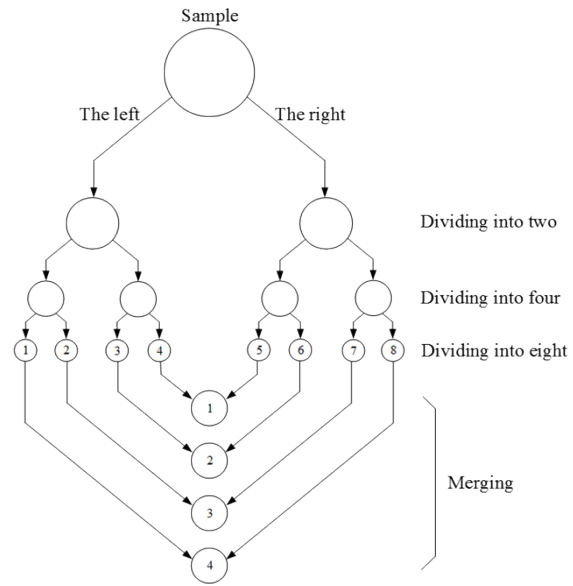


Figure S2. The Carpenter left-right balancing method.